### **SPECIFICATIONS**

CUSTOMER :

SAMPLE CODE : SH102768T001-ZAA

MASS PRODUCTION CODE : PH102768T001-ZAA

SAMPLE VERSION : 01

SPECIFICATIONS EDITION : 003

DRAWING NO. (Ver.) : LMD- PH102768T001-ZAA (Ver.002)

PACKAGING NO. (Ver.) : PKG- PH102768T001-ZAA (Ver.001)

## **Customer Approved**

Date:

Approved	Checked	Designer
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Oliver Huang	Oliver Huang	Lambert Lee

Preliminary specification for design input

■ Specification for sample approval

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# **History of Version**

Date ( mm / dd / yyyy )	Ver.	Edi.	Description	Page	Design by
08/05/2014	01	001	New Drawing.	-	Lambert
08/18/2014	01	002	First sample	-	Lambert
01/20/2015	01	003	Modify LCM Drawing	Appendix	Lambert
					<i></i>

Total: 26 Page



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## 1.1 Features

Item	Standard Value
Screen size(inch)	12.1 inch
Display Type	1024 * (RGB) * 768
LCD Type	Normally white
Touch panel	
Color configuration	R.G.B. Vertical Stripe
Backlight Type	LED B/L
Weight	545 g(max)
Interface	LVDS
Support Color	16.7M
Surface Treatment	Anti-glare & hardness 3H
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	279.0 (W) * 209.0 (L) * 9.0 (H)	mm

## LCD panel

Item	Standard Value	
Active Area	245.76 (W) * 184.32 (L)	mm

Note: For detailed information please refer to LCM drawing



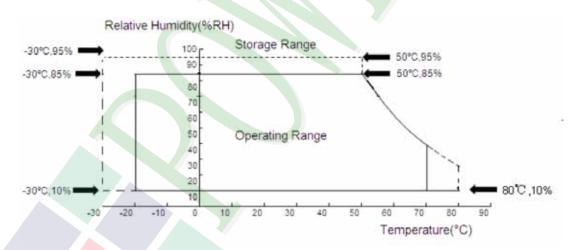
## 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Min.	Max.	Unit	Condition
Input power supply	VDD	-0.5	+5.0	V	(1)
Operating Temperature	T <sub>OP</sub>	-20	+70	°C	(1)(2)(3)(4)
Operating Humidity	H <sub>OP</sub>	10	85	%RH	-
Storage Temperature	T <sub>ST</sub>	-30	+80	°C	_
Storage Humidity	H <sub>ST</sub>	10	95	%RH	· -

Note (1): Humidity: 85%RH Max. (T<=40  $^{\circ}$ C ) Note static electricity Maximum wet bulb temperature at 39  $^{\circ}$ C or less. (T>40  $^{\circ}$ C ) No condensation

- Note (2): There is a possibility of causing deterioration in the irregularity and others of the screen and the display fineness though the liquid crystal module doesn't arrive at destruction when using it at  $80 \sim 85~^{\circ}\text{C}$  or -20  $^{\circ}\text{C}$ .
- Note (3): There is a possibility of causing the fineness deterioration by the prolonged use in the (high temperature) humidity environment (60% or more).
- Note (4): In the operating temperature item, the low temperature side is the ambient temperature regulations. The high temperature side is the panel surface temperature regulations.
- Note (5): Storage Range & Operating Range Picture:



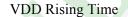


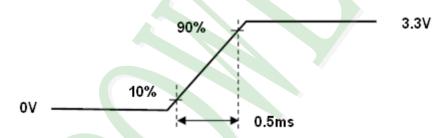
### 1.4 DC Electrical Characteristics

#### **TFT LCD Module**

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply	VDD	Note (2)(4)	3.0	3.3	3.6	V
		VDD =3.3V				
VDD Current	IDD	Black Pattern	-	-	250	mA
		Note (3)(4)				
VDD Power		VDD =3.3V				<i>y</i>
	PDD	Black Pattern			0.825	W
Consumption		Note (3)(4)				
Rush Current	Irush	Note (1)(4)	-	-	3	Α
Allowable Logic/LCD	VDDrp	Note (4)	_	-	200	mV
Drive Ripple Voltage	v DDIp	11010 (4)			200	1110

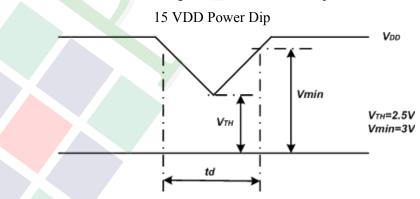
Note (1): Measure Condition





**Note** : (2) VDD Power Dip Condition

If VTH<VDD $\leq$ Vmin , then td $\leq$ 10ms ; When the voltage returns to normal our panel must revive automatically.



Note (3) Frame Rate=60Hz, VDD=3.3V,DC Current.

Note (4) Operating temperature 25°C, humidity 55%RH



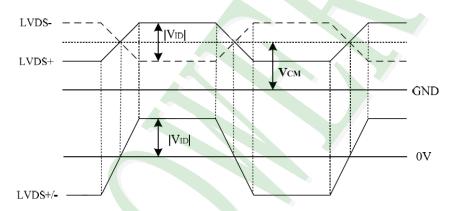
#### **Switching Characteristics for LVDS Receiver**

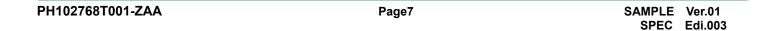
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Differential Input High Threshold	Vth	Vcm=+1.2V	-	-	+100	mV
Differential Input Low Threshold	VtI	Vcm=+1.2V	-100	-	-	mV
Magnitude Differential Input Voltage	VID	-	100	-	600	mA
Common Mode Voltage	VCM	-	VID /2+0.6	1.2	1.8- VID /2	V
Common Mode Voltage Offset	△VCM	Vcm=+1.2V		-	50	mV

Note: (1) Input signals shall be low or Hi- resistance state when VDD is off.

(2) All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD.

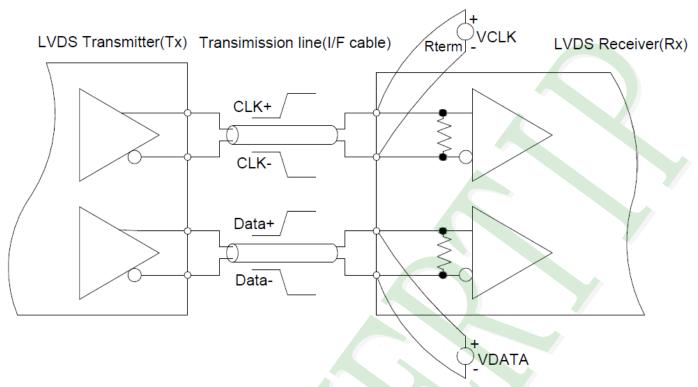
## **Voltage Definitions**



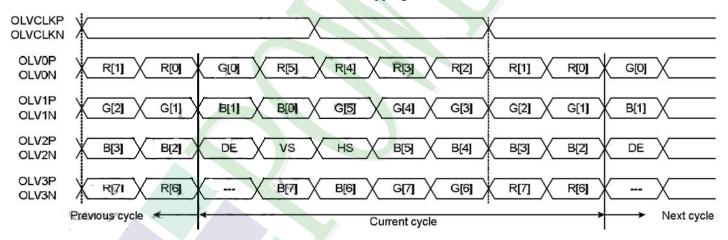




#### Measurement System



### Data Mapping





## 1.5 Optical Characteristics

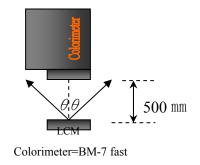
TFT LCD Panel Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response time	Rise	Tr+Tf	Ta = $25^{\circ}$ C $\theta$ X, $\theta$ Y = $0^{\circ}$	-	16	-	ms	Note2
	Тор	θΥ+		70	80	-		
Viewing angle	Bottom	θΥ-	CR ≥ 10	70	80	-	Dog	Note4
(With B/L on / With 3D-LCD barrier off)	Left	θX-	CR 2 10	70	80	-	Deg.	Note4
	Right	θX+		70	80	ľ		
Contrast ratio		CR		720	800	-	-	ı
	White	Х		0.255	(0.305)	0.355		
		Υ		0.275	(0.325)	0.375		
	Red	Х	Ta = 25°C	-	TBD	-		
Color of CIE Coordinate		Υ		-	TBD	-	_	Note1
Color of OIL Coordinate	Green	Х	$\theta X$ , $\theta Y = 0^{\circ}$		TBD	-		NOICT
	Green	Y		-	TBD	-		
	Blue	X		-	TBD	-		
	Diac	Υ		-	TBD	-		
Average Brightnes Pattern=white displa		IV	TBD	315	350	ı	cd/m <sup>2</sup>	Note1
Uniformity		△B	TBD	70	-	-	%	Note1

#### Note1:

- $1 : \triangle B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
  - a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance:  $500 \pm 50 \text{ mm}$  ,  $(\theta = 0^{\circ})$
  - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%



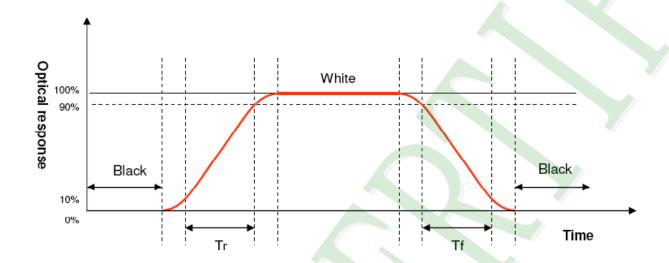




### Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (rising time) and from "white" to "black" (falling time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

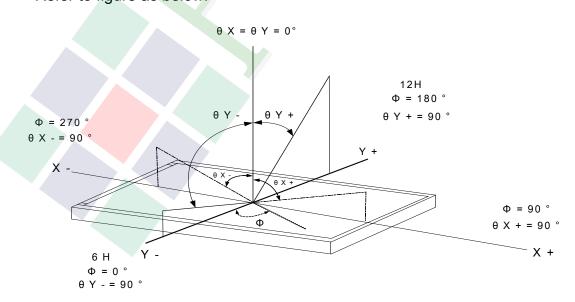
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





## 1.6 Backlight Characteristics

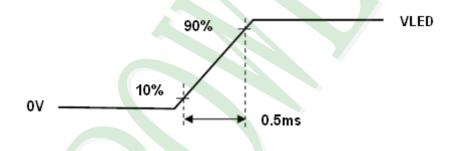
Item	Symbol	Min.	Тур.	Max.	Units	Condition
LED Voltage	VL	10.8	12	12.6	V	
LED Current	ΙL	-	240	-	m A	
LED Forward Voltage	VF	2.8	3.3	3.6	V	<b>Ta=25</b> °C
LED Forward Current	lF		60		m A	
BL Power Consumption	PL	-	-	6.1	W	
LED Life Time	-	(30,000)	-	-	Hours	Ta=25°C/IL=240mA Note (1)

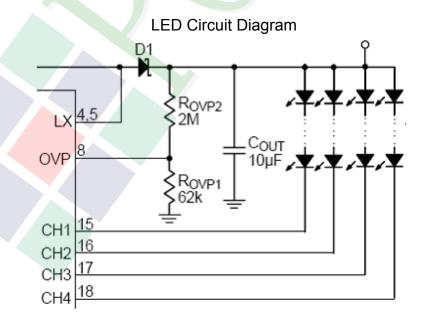
Note (1) The LED life time define as the estimated time to 50% degradation of initial luminous.

Note (2) Operating temperature 25 °C , humidity 55%RH.

Note (3) A higher LED power supply voltage will result in better power efficiency. Keep the V\_LED between 12V and 12.6V is strongly recommended.

### **LED Rush Current Measure Condition**







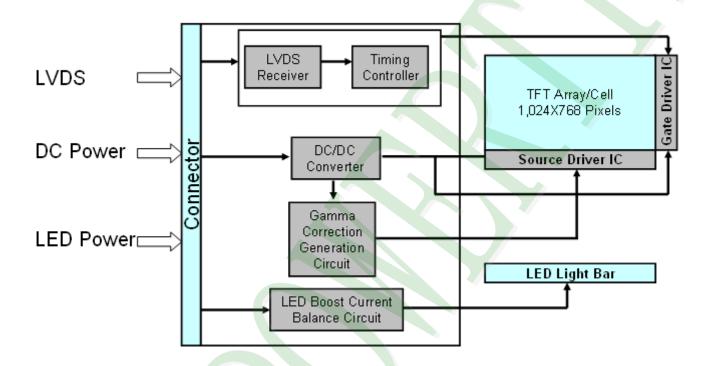
### 2. MODULE STRUCTURE

### 2.1 Counter Drawing

## 2.1.1 LCM Mechanical Diagram

\* See Appendix

### 2.1.2 Block Diagram





# 2.2 Interface Pin Description

## **LVDS**

Pin No.	Symbol	Description
1	VDD	Power Supply, 3.3V (typical)
2	VDD	Power Supply, 3.3V (typical)
3	VSS	Ground
4	REV	Reverse Scan selection
4	IXLV	{High:2.5(min), 3.3(typ),3.6(max); Low: 0.5(max)}
5	Rin1-	-LVDS differential data input (R0-R5,G0)
6	Rin1+	+LVDS differential data input (R0-R5,G0)
7	VSS	Ground
8	Rin2-	-LVDS differential data input (G1-G5,B0-B1)
9	Rin2+	+LVDS differential data input (G1-G5,B0-B1)
10	VSS	Ground
11	Rin3-	-LVDS differential data input (B2-B5,HS,VS,DE)
12	Rin3+	+LVDS differential data input (B2-B5,HS,VS,DE)
13	VSS	Ground
14	CIkIN-	-LVDS differential clock input
15	CIkIN+	+LVDS differential clock input
16	GND	Ground
17	Rin4-	-LVDS differential data input (R6-R7,G6-G7,B6-B7)
18	Rin4+	+VDS differential data input (R6-R7,G6-G7,B6-B7)
19	SEL68	6/8 bits LVDS data input selection(H:8bit L/NC:6bit)
20	Bist	Internal use

Note(1): All input signals shall be low or Hi-resistance state when VDD is off.

## BL

Pin No.	Function
1	VCC(12V input)
2	GND
3	On/Off(5V-ON,0V-OFF)
4	Dimming(PWM)
5	NC



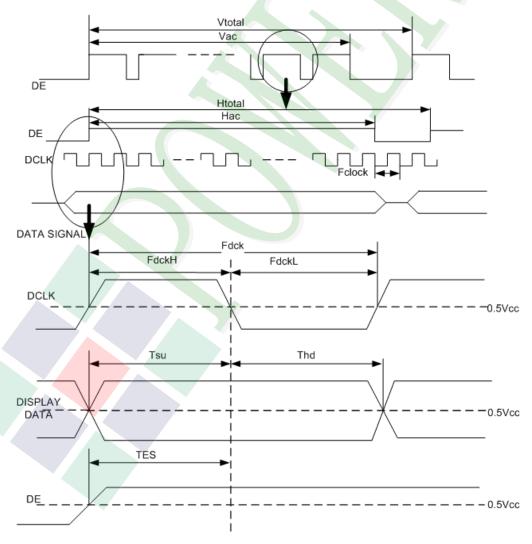
## 2.3 Timing Characteristics

## **Interface Timings**

Parameter	Symbol	Unit	Min.	Тур.	Max.
LVDS Clock Frequency	Fclk	MHz	50	65	80
H Total Time	HT	Clocks	1100	1344	2047
H Active Time	HA	Clocks	1024	1024	1024
H Blanking Time	HBL	Clocks	76	320	1023
V Total Time	VT	Lines	776	806	1023
V Active Time	VA	Lines	768	768	768
V Blanking Time	VBL	Lines	8	38	255
Frame Rate	Vsync	Hz	-	60	-

Note: H Blanking Time and V Blanking Time can not be changed at every frame.



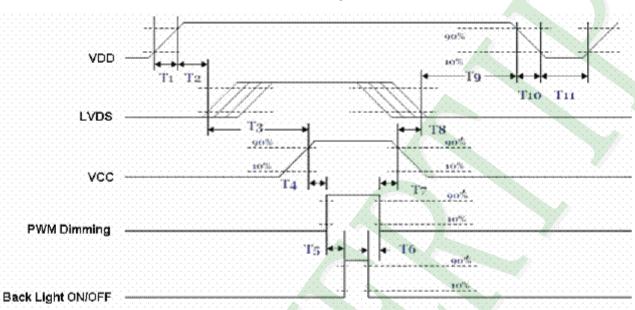




## **Power ON/OFF Sequence**

Power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-resistance state or low level when VDD is off.

#### **Power Sequence**



# Power ON/OFF sequence timing

<b>D</b>	Value			
Parameter	Min.	Тур.	Max.	Units
T1	0.5	-	10	[ms]
T2	30	40	50	[ms]
Т3	200		-	[ms]
T4	10	F	-	[ms]
T5	10	1_	-	[ms]
Т6	0	_	-	[ms]
Т7	10	-	-	[ms]
Т8	100	-	-	[ms]
Т9	0	16	50	[ms]
T10	-	-	10	[ms]
<b>J11</b>	1000	-	-	[ms]

#### Note

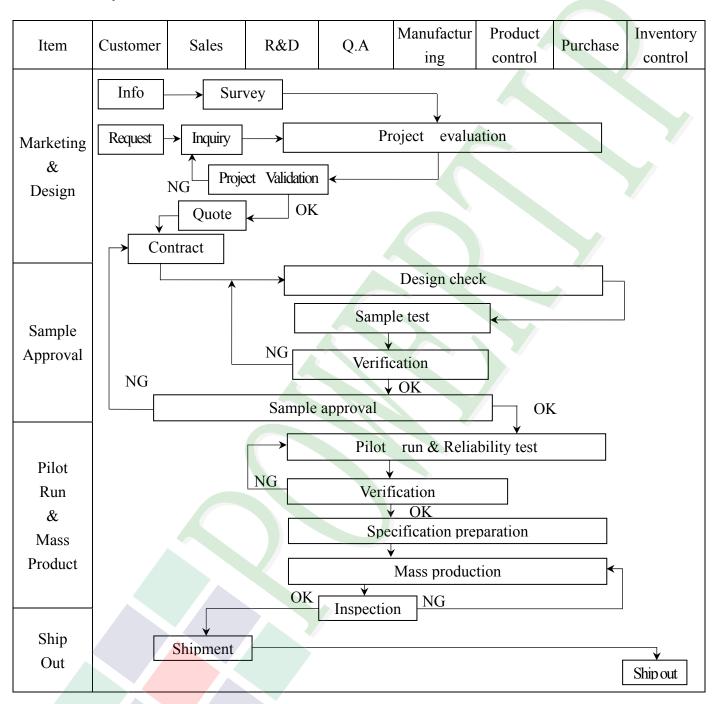
(1) Power On Sequence: VCC-> AVDD -> VGL -> VGH -> Data -> B/L

(2) Power Off Sequence: B/L-> Data -> VGH -> VGL -> AVDD -> VCC

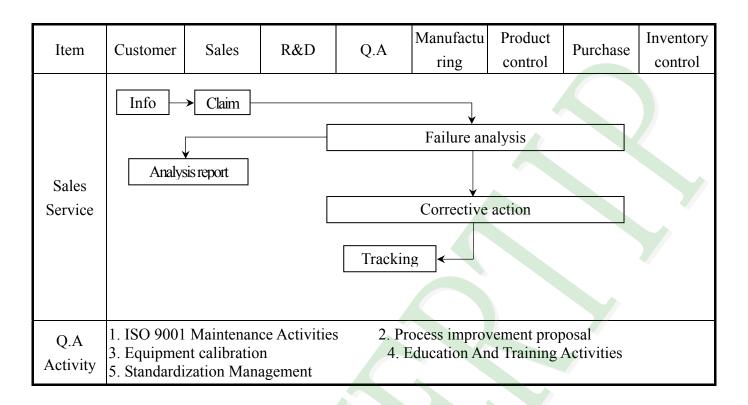


# 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart



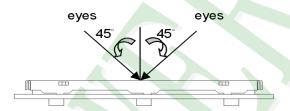




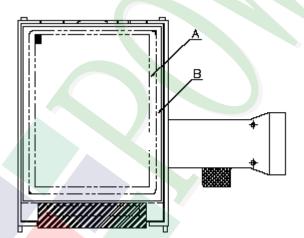


### 3.2. Inspection Specification

- ◆Scope: The document shall be applied to TFT-LCD Module for 3.5" ~12.1" (Ver.B01).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- **◆**Equipment : Gauge ` MIL-STD ` Powertip Tester ` Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5
- **♦**OUT Going Defect Level: Sampling.
- ◆Standard of the product appearance test:
  - a. Manner of appearance test:
  - (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
  - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



NO	Item	Criterion	Level	
		1. 1The part number is inconsistent with work order of production.      1. 2 Mixed product types.		
01	Product condition			
		1. 3 Assembled in inverse direction.	Major	
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major	
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major	
		4. 1 Missing line character and icon.	Major	
		4. 2 No function or no display.	Major	
04	Electrical Testing	4. 3 Display malfunction.	Major	
		4. 4 LCD viewing angle defect.	Major	
		4. 5 Current consumption exceeds product specifications.		
		Item Acceptance (Q'ty)		
		Bright Dot ≤ 4		
	Dot defect	Dot Dark Dot ≤ 5		
		Defect Joint Dot ≤ 3		
	(Bright dot `	Total ≤ 7		
05	Dark dot)		Minor	
	On Barbar	5. 1 Inspection pattern: full white, full black, Red, Green and		
	On -display	blue screens.		
		5. 2 It is defined as dot defect if defect area >1/2 dot.		
	5. 3 The distance between two dot defect ≥5 mm.			
		5.4 Bright dot that can be seen through 8% ND filter.		



_	iicauon for 1f1-L	CD Module 3. 5" ~12. 1" :			
NO	Item	Criterion			
		6. 1 Round type ( Non-display or display) :			
		Acceptance (Q'ty)			
		Dimension (diameter : Φ)  A area  B area			
	Black or white dot `scratch `	$\Phi \le 0.25$ Ignore	<b>&gt;</b>		
	contamination	$0.25 < \Phi \le 0.50$			
	Round type	$\Phi > 0.50$ Ignore			
	$\begin{array}{c c} & & & \\ \hline & & & \\ \hline & & & \\ \hline \end{array}$	Total 5			
06		6. 2 Line type( Non-display or display) :	Minor		
	$\Phi = (x+y)/2$	Acceptance (Q'ty)			
	Line type	Length (L) Width (W) A area B area			
	✓ / ¥ W	W ≤ 0.03 Ignore			
	→ L +	$L \le 10.0$ $0.03 < W \le 0.05$ 4			
		L $\leq 5.0$ 0.05 < W $\leq 0.10$ 2 Ignore			
		$W > 0.10 \qquad \frac{\text{As round}}{\text{type}}$			
		Total 5			
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area			
07		$\Phi \le 0.25$ Ignore			
	Polarizer Bubble	$0.25 < \Phi \leq 0.50 \qquad \qquad 4$	Minor		
		$0.50 < \Phi \le 0.80$ 1 Ignore			
		$\Phi > 0.80 \qquad \qquad 0$			
		Total 5			



NO	Item	Criterion		
		Z: The thickness of crack	Y: The width of crack. V: terminal length a: LCD side length	
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and cra	ack between panels:	
		Z Z	Z X	
08	The crack of glass	SP Y [OK]	SP [NG]	Minor
		Seal width Z	Y	
		X Y	Z	
		≤ a Crack can't enter viewing area	≦1/2 t	
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t	



NO	Item	Criterion	Level	
		X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 1. 2 Corner crack:		
		$\begin{array}{ c c c c c }\hline X & Y & Z \\ & \leq 1/5 \text{ a} & \begin{array}{ c c c c }\hline \text{Crack can't enter} & Z & \leq 1/2 \text{ t} \\ & \text{viewing area} & \end{array}$		
		Solution $ z  = 1/5$ a Crack can't exceed the half of SP width. $ z  = 1/2$ t $ z  = $		
08	The crack of glass	8. 2 Protrusion over terminal:	Minor	
		8. 2. 1 Chip on electrode pad:		
		W		
		Back $\leq a$ $\leq W$ $\leq 1/2 t$		



NO	Item	Criterion		
08	The crack of glass	Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 2. 2 Non-conductive portion:  X  X  X  Y  Z  S  A  A  Y: The width of crack. W: terminal length a: LCD side length  8. 2. 2 Non-conductive portion:  W  X  X  Y  Z  S  A  A  Y  Z  S  If the chipped area touches the ITO terminal, over 2/3 of  1. the ITO must remain and be inspected  according to electrode terminal specifications.  8. 2. 3 Glass remain:  X  Y  Z  S  A  Y  Z  S  A  S  A  S  A  S  A  S  A  S  A  S  A  S  S	Minor	



NO	Item	Criterion	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
		10. 1 Pin type `quantity` dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
10	General appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



# 4. RELIABILITY TEST

4.1 Reliability Test Condition

<b>— —</b>	Reliability Test Condition (Ver. Do 1)			
NO.	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.		
2	Low Temperature Storage Test	Keep in - 30 ±2°C 96 hrs Surrounding temperature, then ste	orage at normal condition 4hrs.	
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)		
4	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins})  (5\text{mins})  (5\text{mins})$ $10 \text{ Cycle}$ Surrounding temperature, then storage at normal condition 4hrs.		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-  1. Temperature ambiance: 15°C  2. Humidity relative: 30%~60%  3. Energy Storage Capacitance(C  4. Discharge Resistance(Rd): 33C  5. Discharge, mode of operation: Single Discharge (time between (Tolerance if the output voltage i	s+Cd): 150pF ±0% の公 ±0% successive discharges at least 1 sec)	
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1. 5 mm</li> <li>Each direction (X ` Y ` Z) duration for 2 Hrs</li> </ol>		
7	Drop Test (Packaged)	Packing Weight (Kg)  0 ~ 45. 4  45. 4 ~ 90. 8  90. 8 ~ 454  Over 454  Drop Direction: %1 corner / 3 edg	122 76 61 46	



### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### 5.2 HANDLING

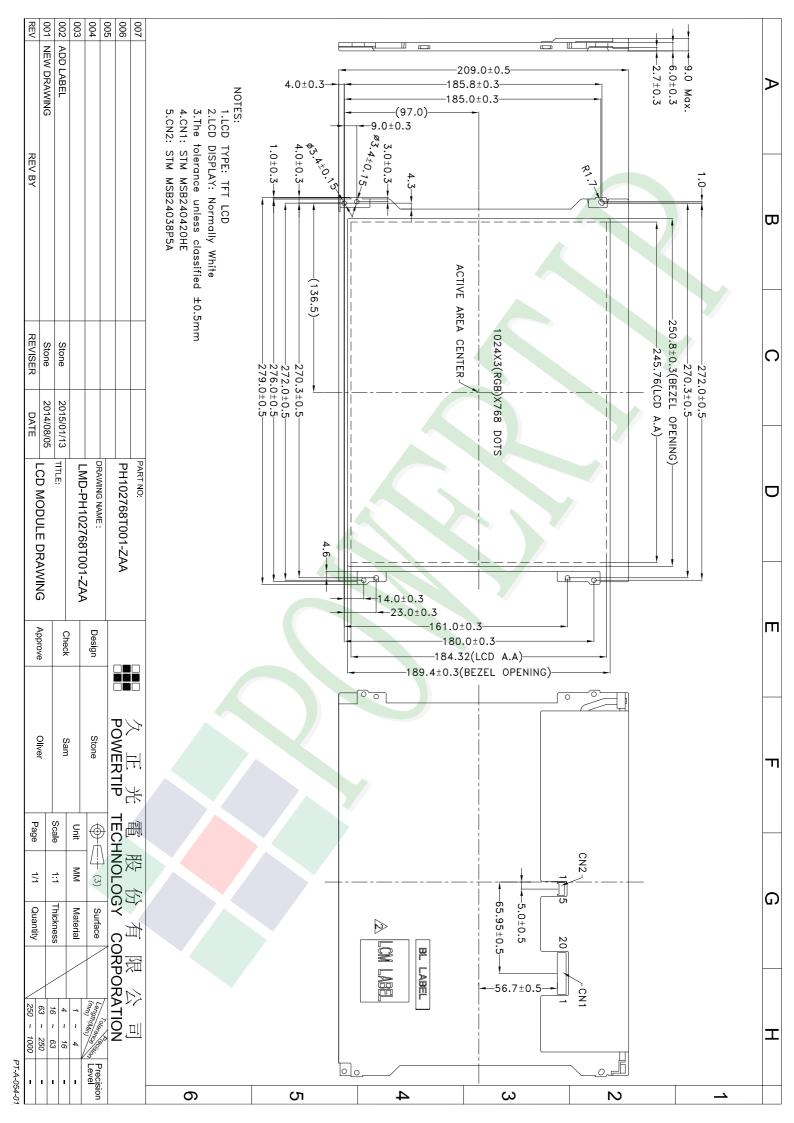
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

#### 5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
  - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
  - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



#### Approve Check Contact LCM包裝規格書 Ver.001 LCM Packaging Specifications Oliver Sam Stone Documents NO. PKG-PH102768T001-ZAA 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight 1 成品 (LCM) 279.0 X 209.0 20 PH102768T001-ZAA 0.442 8.84 2 靜電袋(1)Antistatic Bag 20 3 上蓋(2)EPE(Cover) 520 X 315 X 65 FOAM000000147 0.16 1 0.16 下座(3)EPE(Bottom) 520 X 315 X 105 4 0.335 1 0.335 FOAM000000148 5 外紙箱(4)Carton BX52732536CCBA 527 X 325 X 360 1.092 1 1.092 6 2.一 整箱總重量 (Total LCD Weight in carton ): 10.43 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): Total LCM quantity in carton: quantity per EPE x no of EPE 20 (2)上蓋 仆 EPE(Cover) (1)靜電袋+LCM 仆 Antistatic Bag+LCM (3)下座 EPE(Bottom) (4)外紙箱 Carton 記 事 項 (REMARK) 4. 使用供應商原包裝靜電袋。